PRELIMINARY SPECIFICATION

NEC ELECTRON DEVICE

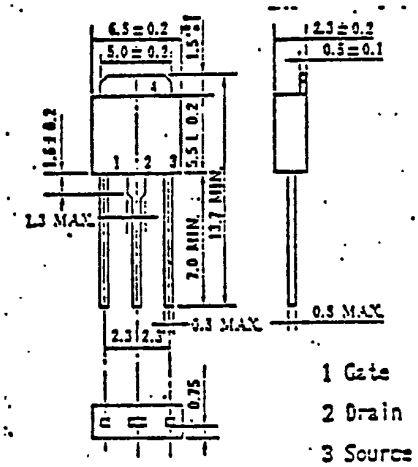
MOS FIELD EFFECT TRANSISTOR

2SK801

FAST SWITCHING N-CHANNEL SILICON POWER MOS FET

PACKAGE DIMENSIONS

in millimeters



Features

Suitable for switching power supplies, actuater controls and pulse circuits
4V Gate Drive —— Logic level ——
Low RDS(on)
No second breakdown

Absolute Maximum Ratings(Ta=25°C)

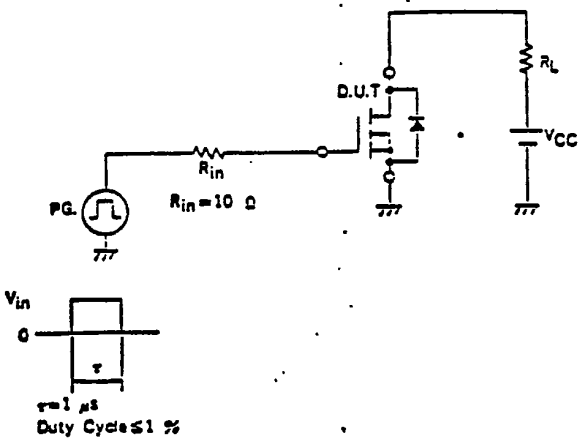
Drain to Source Voltage	VDSS	30V
Gate to Source Voltage	VGSS	± 20V
Continuous Drain Current	ID(DC)	±2.0A
Pulse Drain Current	ID(pulse)*±	8.0A
Total Power Dissipation	PT	0.6W
Total Power Dissipation	PT**	12W
Channel Temperature	Tch	150 °C
Storage Temperature	Tstg	-55to+150 °C

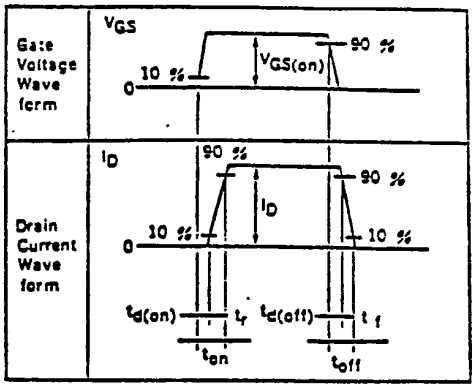
* PW≦100 μs,Duty Cycles ≦2 %
** Tc=25 °C

Electrical Characteristics (Ta=25 °C)

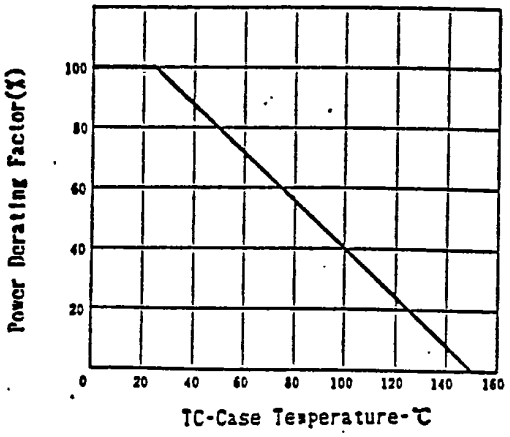
Characteristics	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain Leakage Current	IDSS			10	μA	VDS=30 V,VGS=0
Gate to Source Leakage Current	IGSS			100	nA	VGS= 20V,VDS=0
Gate to Source Cutoff Voltage	VGS(off)	1.0		2.5	V	VDS=10V,ID=1.0mA
Forward Transfer Admittance	|yfs|	1.0			S	VDS=10V,ID=1.0A
Drain To Source On-State Resistance	RDS(on)			0.35	Ω	VGS=10V,ID=1.0A
Drain to Source On-State Resistance	RDS(on)			0.50	Ω	VGS=4.0V ID=1.0A
Input Capacitance	Ciss		270		pF	VDS= 10V
Output Capacitance	Coss		150		pF	VGS=0
Reverse Transfer Capacitance	Crss		70		pF	f=1.0MHz
Turn-On Delay Time	td(on)		45		ns	ID=1.0A,
Rise Time	tr		40		ns	VGS(on)= 10V
Turn-Off Delay Time	td(off)		450		ns	Vcc=15V,
Fall Time	tf		110		ns	RL=15 Ω

TURN-ON AND TURN-OFF TIME TEST CIRCUIT

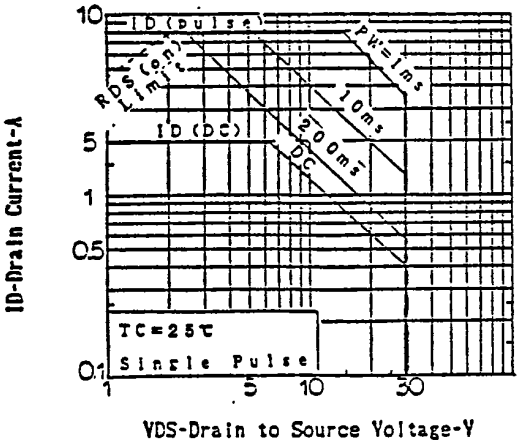




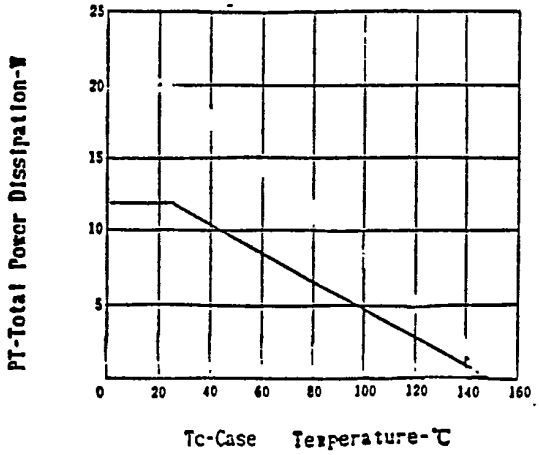
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



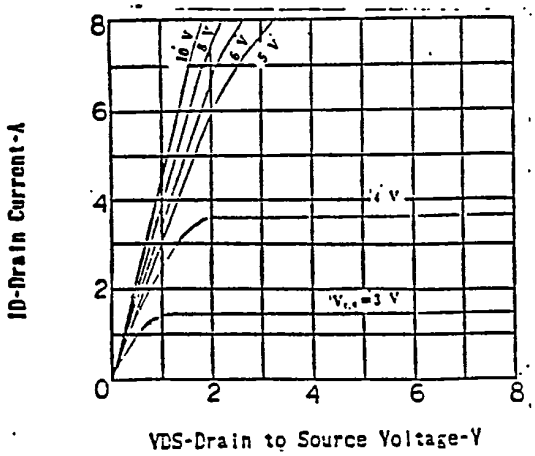
FORWARD BIAS SAFE OPERATING AREA



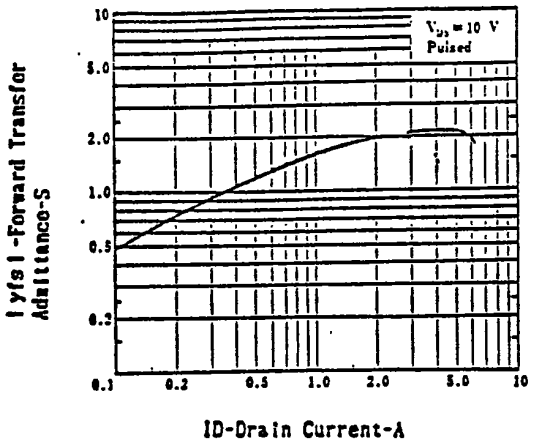
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

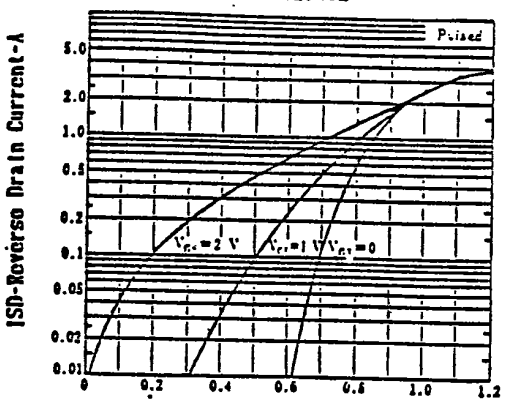


FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



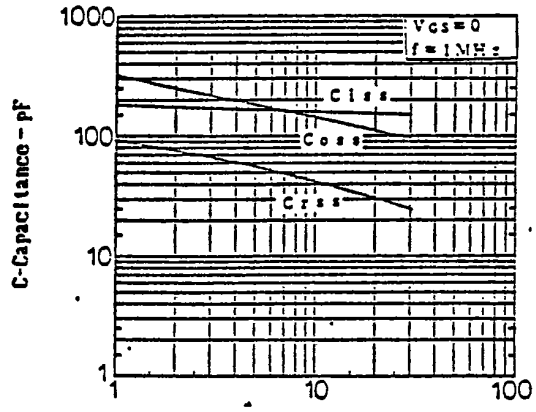
ID-Drain Current-A

SOURCE TO DRAIN DIODE FORWARD VOLTAGE



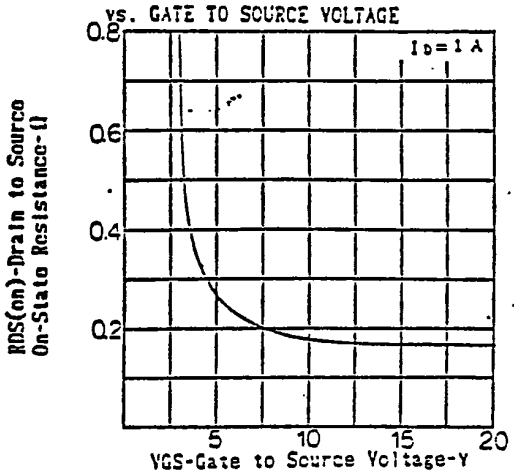
VSD-Source to Drain Voltage-V

CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



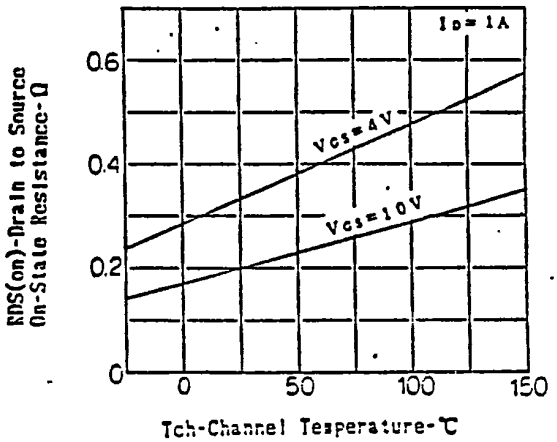
VDS-Drain to Source Voltage-V

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



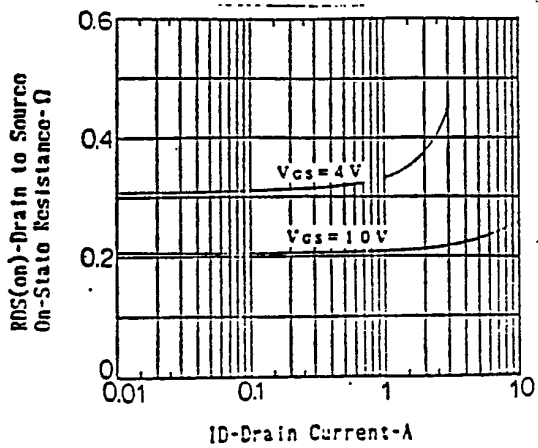
VGS-Gate to Source Voltage-V

DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



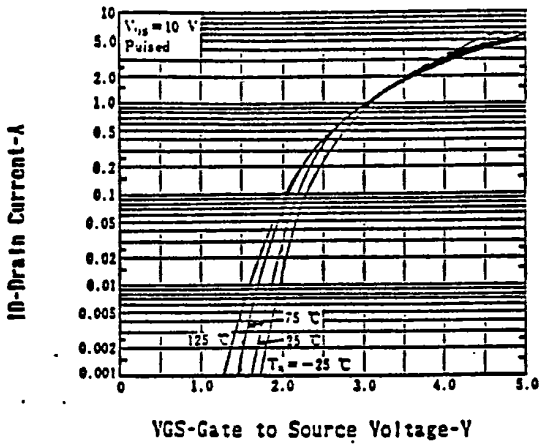
Tch-Channel Temperature-℃

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

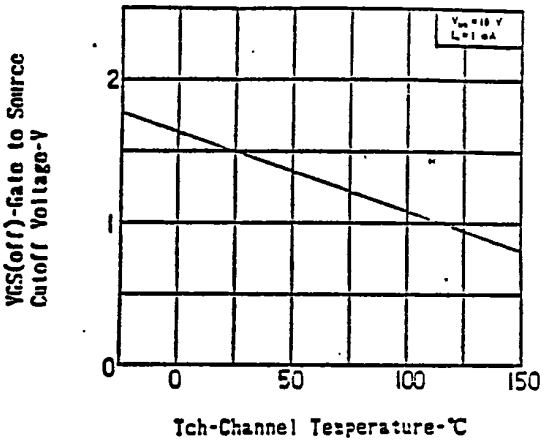


ID-Drain Current-A

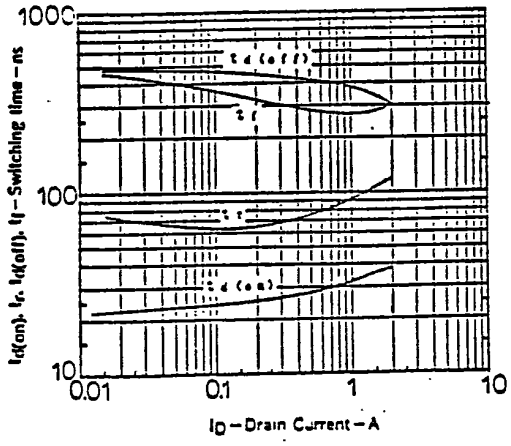
TRANSFER CHARACTERISTICS



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



SWITCHING CHARACTERISTICS



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